74HC244; 74HCT244

Octal buffer/line driver; 3-state

Rev. 7 — 27 July 2021

Product data sheet

1. General description

The 74HC244; 74HCT244 is an 8-bit buffer/line driver with 3-state outputs. The device can be used as two 4-bit buffers or one 8-bit buffer. The device features two output enables ($1\overline{OE}$ and $2\overline{OE}$), each controlling four of the 3-state outputs. A HIGH on $n\overline{OE}$ causes the outputs to assume a high-impedance OFF-state. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 to 6.0 V
- · CMOS low power dissipation
- · High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Input levels:
 - For 74HC244: CMOS level
 - For 74HCT244: TTL level
- Octal bus interface
- Non-inverting 3-state outputs
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

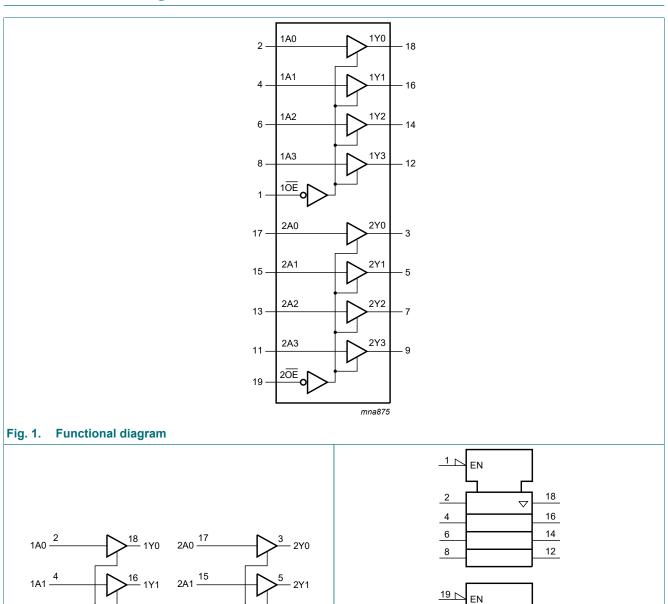
3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | | | | | | |
|-------------|-------------------|----------|--|----------|--|--|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | | | |
| 74HC244D | -40 °C to +125 °C | SO20 | plastic small outline package; 20 leads; | SOT163-1 | | | | | | | |
| 74HCT244D | | | body width 7.5 mm | | | | | | | | |
| 74HC244PW | -40 °C to +125 °C | TSSOP20 | plastic thin shrink small outline package; | SOT360-1 | | | | | | | |
| 74HCT244PW | | | 20 leads; body width 4.4 mm | | | | | | | | |
| 74HC244BQ | -40 °C to +125 °C | DHVQFN20 | plastic dual in-line compatible thermal | SOT764-1 | | | | | | | |
| 74HCT244BQ | | | enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm | | | | | | | | |



4. Functional diagram



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15

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Fig. 3. IEC logic symbol

2/15

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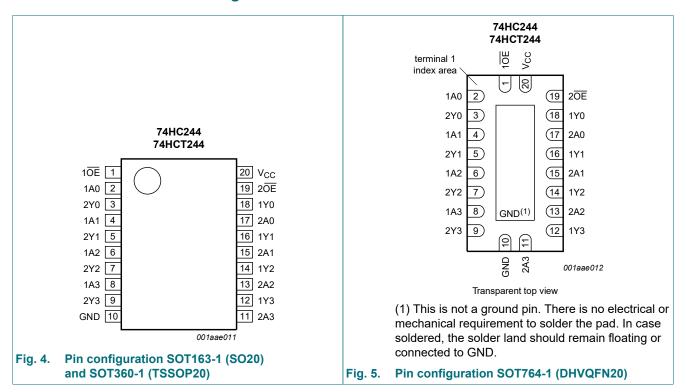
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10E -1

Fig. 2. Logic symbol

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|--------------------|----------------|----------------------------------|
| 10E, 20E | 1, 19 | output enable input (active LOW) |
| 1A0, 1A1, 1A2, 1A3 | 2, 4, 6, 8 | data input |
| 2Y0, 2Y1, 2Y2, 2Y3 | 3, 5, 7, 9 | bus output |
| GND | 10 | ground (0 V) |
| 2A0, 2A1, 2A2, 2A3 | 17, 15, 13, 11 | data input |
| 1Y0, 1Y1, 1Y2, 1Y3 | 18, 16, 14, 12 | bus output |
| V _{CC} | 20 | supply voltage |

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

| Input nOE | | Output |
|--------------|-----|--------|
| nOE | nAn | nYn |
| L | L | L |
| L | Н | Н |
| Н | X | Z |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|------|------|------|
| V _{CC} | supply voltage | | -0.5 | +7 | V |
| I _{IK} | input clamping current | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ | - | ±20 | mA |
| I _{OK} | output clamping current | $V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$ | - | ±20 | mA |
| Io | output current | -0.5 V < V _O < V _{CC} + 0.5 V | - | ±35 | mA |
| I _{CC} | supply current | | - | 70 | mA |
| I _{GND} | ground current | | -70 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | [1] | - | 500 | mW |

^[1] For SOT163-1 (SO20) package: P_{tot} derates linearly with 12.3 mW/K above 109 °C. For SOT360-1 (TSSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C. For SOT764-1 (DHVQFN20) package: P_{tot} derates linearly with 12.9 mW/K above 111 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------------|-------------------------|-----|------|-----------------|------|
| 74HC24 | 4 | | , | | | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | V |
| V _I | input voltage | | 0 | - | V _{CC} | V |
| Vo | output voltage | | 0 | - | V _{CC} | V |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 2.0 V | - | - | 625 | ns/V |
| | | V _{CC} = 4.5 V | - | 1.67 | 139 | ns/V |
| | | V _{CC} = 6.0 V | - | - | 83 | ns/V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| 74HCT2 | 44 | | | | | |
| V _{CC} | supply voltage | | 4.5 | 5.0 | 5.5 | V |
| Vı | input voltage | | 0 | - | V _{CC} | V |
| Vo | output voltage | | 0 | - | V _{CC} | V |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 4.5 V | - | 1.67 | 139 | ns/V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | 25 °C | | -40 °C to | o +85 °C | -40 °C to | +125 °C | Unit |
|---------------------------|--------------------------|---|------|-------|------|-----------|----------|-----------|----------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HC24 | 4 | | | | ' | | 1 | | <u>'</u> | |
| in a substant | | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | input voltage | V _{CC} = 4.5 V | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | V _{CC} = 6.0 V | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| V _{IL} LOW-level | | V _{CC} = 2.0 V | - | 8.0 | 0.5 | - | 0.5 | - | 0.5 | V |
| | input voltage | V _{CC} = 4.5 V | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | V _{CC} = 6.0 V | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| V _{OH} | HIGH-level | V _I = V _{IH} or V _{IL} | | | | | | | | |
| | output voltage | $I_O = -20 \mu A; V_{CC} = 2.0 V$ | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | Voltage | I _O = -20 μA; V _{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_O = -20 \mu A; V_{CC} = 6.0 V$ | 5.9 | 6.0 | - | 5.9 | - | 5.9 | - | V |
| | | I_{O} = -6.0 mA; V_{CC} = 4.5 V | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| | | I_{O} = -7.8 mA; V_{CC} = 6.0 V | 5.48 | 5.81 | - | 5.34 | - | 5.2 | - | V |
| V _{OL} | LOW-level | $V_I = V_{IH}$ or V_{IL} | | | | | | | | |
| | output voltage | I_{O} = 20 μ A; V_{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | Voltage | I _O = 20 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 6.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | $I_O = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$ | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V |
| I _I | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$ | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μΑ |
| l _{OZ} | OFF-state output current | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND | - | - | ±0.5 | - | ±5.0 | - | ±10 | μА |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$ | - | - | 8.0 | - | 80 | - | 160 | μΑ |
| C _I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

| Symbol | Parameter | Conditions | | 25 °C | | -40 °C to | o +85 °C | -40 °C to | +125 °C | Unit |
|------------------|---------------------------------|---|------|-------|------|-----------|----------|-----------|----------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HCT2 | 44 | | | | ' | | 1 | | <u>'</u> | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | 1.6 | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | | 1.2 | 0.8 | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | Ι _Ο = -20 μΑ | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | ٧ |
| | Voltage | I _O = -6 mA | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| V _{OL} | LOW-level | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | I _O = 20 μA | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | Voltage | I _O = 6.0 mA | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V |
| l _l | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μΑ |
| l _{oz} | OFF-state output current | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$; $I_O = 0 \text{ A}$ | - | - | 8.0 | - | 80 | - | 160 | μΑ |
| ΔI _{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$ | - | 70 | 252 | - | 315 | - | 343 | μA |
| C _I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; for test circuit see Fig. 8.

| Symbol | Parameter | Conditions | | 25 °C | | -40 °C to | o +85 °C | -40 °C to | +125 °C | Unit |
|------------------|-------------------------------------|--|-----|-------|-----|-----------|----------|-----------|---------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | 1 |
| 74HC24 | 4 | | | | | | | | | |
| t _{pd} | propagation | nAn to nYn; see Fig. 6 [1] | | | | | | | | |
| | delay | V _{CC} = 2.0 V | - | 30 | 110 | - | 145 | - | 165 | ns |
| | | V _{CC} = 4.5 V | - | 11 | 22 | - | 28 | - | 33 | ns |
| | | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$ | - | 9 | - | - | - | - | - | ns |
| | | V _{CC} = 6.0 V | - | 9 | 19 | - | 24 | - | 28 | ns |
| t _{en} | enable time | nOE to nYn; see Fig. 7 [2] | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 36 | 150 | - | 190 | - | 225 | ns |
| | | V _{CC} = 4.5 V | - | 13 | 30 | - | 38 | - | 45 | ns |
| | | V _{CC} = 6.0 V | - | 10 | 26 | - | 33 | - | 38 | ns |
| t _{dis} | disable time | nOE to nYn; see Fig. 7 [3] | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 39 | 150 | - | 190 | - | 225 | ns |
| | | V _{CC} = 4.5 V | - | 14 | 30 | - | 38 | - | 45 | ns |
| | | V _{CC} = 6.0 V | - | 11 | 26 | - | 33 | - | 38 | ns |
| t _t | transition time | see Fig. 6 [4] | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 14 | 60 | - | 75 | - | 90 | ns |
| | | V _{CC} = 4.5 V | - | 5 | 12 | - | 15 | - | 18 | ns |
| | | V _{CC} = 6.0 V | - | 4 | 10 | - | 13 | - | 15 | ns |
| C _{PD} | power dissipation capacitance | per buffer; $V_I = GND$ to V_{CC} [5] | - | 35 | - | - | - | - | - | pF |
| 74HCT2 | 44 | 1 | | | | | | ' | 1 | |
| t _{pd} | propagation | nAn to nYn; see Fig. 6 [1] | | | | | | | | |
| | delay | V _{CC} = 4.5 V | - | 13 | 22 | - | 28 | - | 33 | ns |
| | | V _{CC} = 5.0 V; C _L = 15 pF | - | 11 | - | - | - | - | - | ns |
| t _{en} | enable time | \overline{OE} to nYn; V_{CC} = 4.5 V; [2] see Fig. 7 | - | 15 | 30 | - | 38 | - | 45 | ns |
| t _{dis} | disable time | \overline{OE} to nYn; $V_{CC} = 4.5 \text{ V}$; [3] see Fig. 7 | - | 15 | 25 | - | 31 | - | 38 | ns |
| t _t | transition time | $V_{CC} = 4.5 \text{ V}; \text{ see } \frac{\text{Fig. 6}}{}$ [4] | - | 5 | 12 | - | 15 | - | 18 | ns |
| C _{PD} | power dissipation capacitance | per buffer; [5] V _I = GND to V _{CC} - 1.5 V | - | 35 | - | - | - | - | - | pF |

^[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

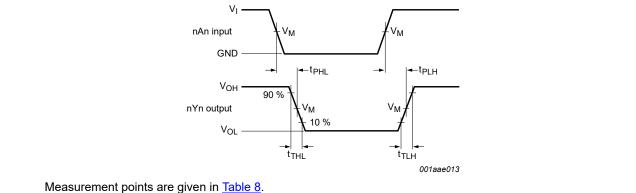
 t_{en} is the same as t_{PZH} and t_{PZL} .

 t_{dis} is the same as t_{PHZ} and t_{PLZ} .

 t_t is the same as t_{THL} and t_{TLH} . C_{PD} is used to determine the dynamic power dissipation (P_D in μW): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz;

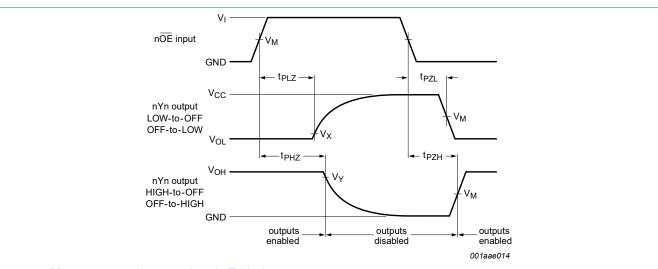
 C_L = output load capacitance in pF; V_{CC} = supply voltage in V; N = number of inputs switching; Σ ($C_L \times V_{CC}$ $^2 \times f_o$) = sum of outputs.

10.1. Waveforms and test circuit



V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 6. Input (nAn) to output (nYn) propagation delays and output transition times



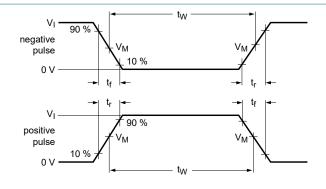
Measurement points are given in Table 8.

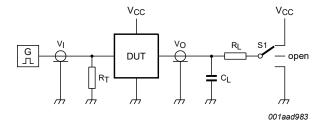
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 7. 3-state enable and disable times

Table 8. Measurement points

| Туре | Input | Output | | |
|----------|-----------------------|-----------------------|-----------------------|-----------------------|
| | V _M | V _M | V _X | V _Y |
| 74HC244 | 0.5 × V _{CC} | 0.5 × V _{CC} | 0.1 × V _{CC} | 0.9 × V _{CC} |
| 74HCT244 | 1.3 V | 1.3 V | 0.1 × V _{CC} | 0.9 × V _{CC} |





Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 C_L = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

S1 = Test selection switch.

Fig. 8. Test circuit for measuring switching times

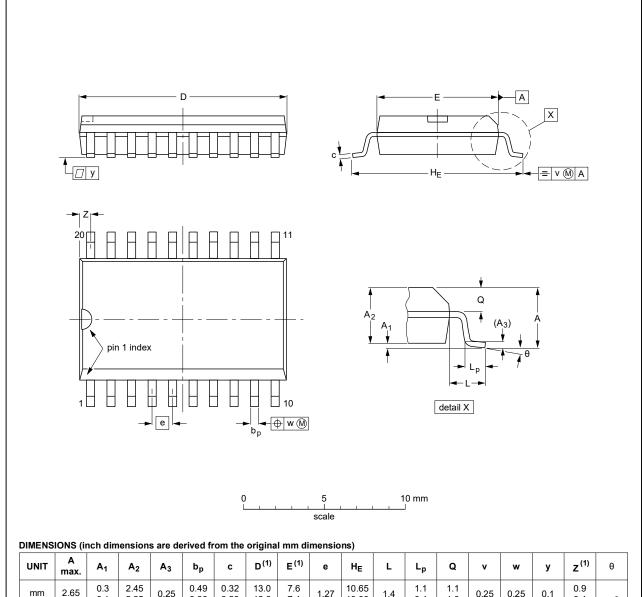
Table 9. Test data

| Туре | Input | | Load | | S1 position | | | |
|----------|------------------------|------|--------------|-------|-------------------------------------|-------------------------------------|-------------------------------------|--|
| | V_{l} t_{r}, t_{f} | | CL | R_L | t _{PHL} , t _{PLH} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} | |
| 74HC244 | V _{CC} | 6 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} | |
| 74HCT244 | 3 V | 6 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} | |

11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



| U | NIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | z ⁽¹⁾ | θ |
|-----|------|-----------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----|
| r | nm | 2.65 | 0.3 0.1 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 13.0 12.6 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° |
| ine | ches | 0.1 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.51 0.49 | 0.30 0.29 | 0.05 | 0.419 0.394 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | 0° |

Note

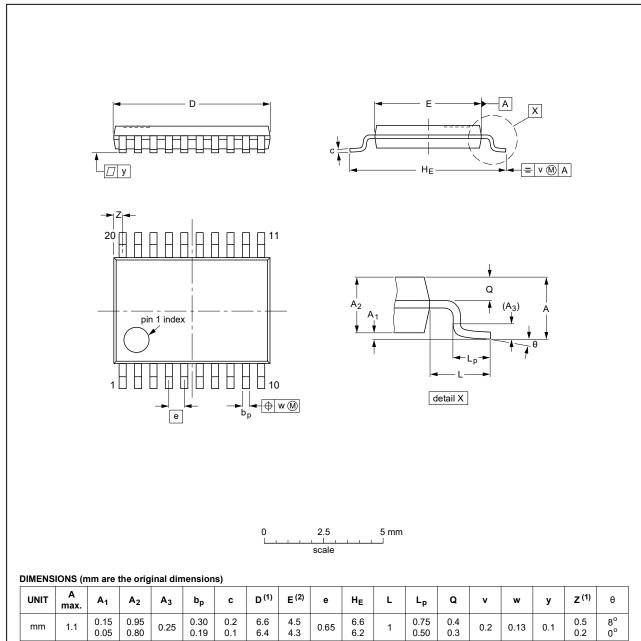
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|--------|--------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT163-1 | 075E04 | MS-013 | | | | 99-12-27 03-02-19 |

Fig. 9. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN | ISSUE DATE |
|--------------------|------------|--------|-------|--|------------|---------------------------------|
| | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT360-1 | | MO-153 | | | | 99-12-27 03-02-19 |

Fig. 10. Package outline SOT360-1 (TSSOP20)

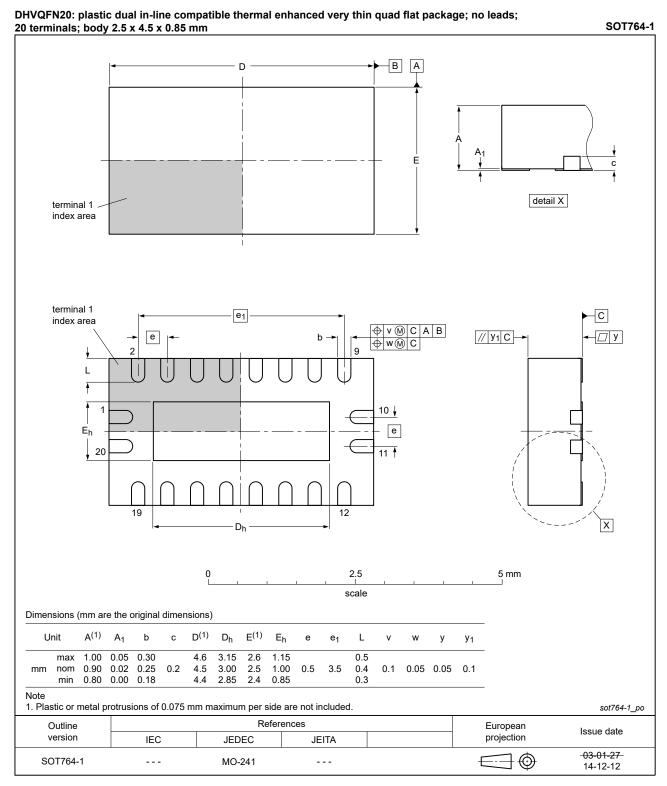


Fig. 11. Package outline SOT764-1 (DHVQFN20)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|---|--|-----------------------|---------------|---------------------|--|--|
| 74HC_HCT244 v.7 | 20210727 | Product data sheet | - | 74HC_HCT244 v.6 | | |
| Modifications: | Type numbers 74HC244DB and 74HCT244DB (SOT339-1/SSOP20) removed. Section 2 updated. | | | | | |
| 74HC_HCT244 v.6 | 20190927 | Product data sheet | - | 74HC_HCT244 v.5 | | |
| Modifications: | The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Table 4: Derating values for P_{tot} total power dissipation have been updated. | | | | | |
| 74HC_HCT244 v.5 | 20160226 | Product data sheet | - | 74HC_HCT244 v.4 | | |
| Modifications: | Type numbers 74HC244N and 74HCT244N (SOT146-1) removed. | | | | | |
| 74HC_HCT244 v.4 | 20120924 | Product data sheet | - | 74HC_HCT244 v.3 | | |
| Modifications: The format of this data sheet has been redesigned to comply with the new guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropria | | | | | | |
| 74HC_HCT244 v.3 | 20051222 | Product data sheet | - | 74HC_HCT244_CNV v.2 | | |
| 74HC_HCT244_CNV v.2 | 19901201 | Product specification | - | - | | |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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